



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN#20250801000.2A
Qualification of Clark-PR as additional wafer Probe site
for select devices
Change Notification / Sample Request

Date: August 08, 2025
To: Mouser PCN

Dear Customer:

Revision A is to inform that PCN samples are not supported for a Wafer probe site change.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Change Management Team
SC Business Services

20250801000.2A**Attachment: 1****Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TPS74501PBQWDRVRQ1	NULL
TPS74533PQWDRVRQ1	NULL
BQ79616PAPRQ1	NULL
TPS1HTC30AQPWPRQ1	NULL
TPS74518PQWDRVRQ1	NULL
UCC21750QDWRQ1	NULL
UCC27284QDRQ1	NULL
TPS7B4256QDDARQ1	NULL
TPS7B8650QDDARQ1	NULL
LM74800QDRRRQ1	NULL
TPS1HC100BQPWPRQ1	NULL
TPS7B4255QDBVRQ1	NULL
TPS3840DL30DBVRQ1	NULL
TPS62816QWRWYRQ1	NULL
UCC21710QDWRQ1	NULL
BQ79600PWRQ1	NULL
BQ79656PAPRQ1	NULL
UCC21738QDWRQ1	NULL
TPS78417QDBVRQ1	NULL
BQ79616HPAPRQ1	NULL
TPS92520QDADRQ1	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:	20250801000.2A	PCN Date:	August 08, 2025						
Title:	Qualification of Clark-PR as additional wafer Probe site for select devices								
Customer Contact:	Change Management Team	Dept:	Quality Services						
Proposed 1st Ship Date:	January 31, 2026	Sample requests accepted until:	N/A						
Change Type:									
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Material							
<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Process							
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Fab Site							
<input type="checkbox"/> Mechanical Specification	<input checked="" type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Material							
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Process							
PCN Details									
Description of Change:									
Revision A is to inform that PCN samples are not supported for a Wafer probe test site change. We apologize for any inconvenience this may have caused.									
Texas Instruments is pleased to announce the qualification of Clark-PR as additional wafer probe test site for the devices listed below.									
<table border="1"> <thead> <tr> <th></th> <th>Current</th> <th>Additional</th> </tr> </thead> <tbody> <tr> <td>Wafer Probe Test site</td> <td>CD-PR (TI Chengdu Probe)</td> <td>CLARK-PR (TI Clark Probe)</td> </tr> </tbody> </table>					Current	Additional	Wafer Probe Test site	CD-PR (TI Chengdu Probe)	CLARK-PR (TI Clark Probe)
	Current	Additional							
Wafer Probe Test site	CD-PR (TI Chengdu Probe)	CLARK-PR (TI Clark Probe)							
Test coverage, insertions, conditions will remain consistent with current testing									
Reason for Change:									
Supply Continuity									
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):									
None									
Impact on Environmental Ratings:									
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.									
RoHS	REACH	Green Status	IEC 62474						
<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change						
Changes to product identification resulting from this PCN:									
None									
Product Affected:									
BQ79600PWRQ1	TPS1HTC30AQPWPRQ1	TPS7B4256QDDARQ1							
BQ79616HPAPRQ1	TPS3840DL29DBVRQ1	TPS92520QDADRQ1							
BQ79616PAPRQ1	TPS3840DL30DBVRQ1	UCC21710QDWRQ1							
BQ79656PAPRQ1	TPS74501PBQWDRVRQ1	UCC21738QDWRQ1							
LM74800QDRRRQ1	TPS74518PQWDRVRQ1	UCC21750QDWRQ1							
LM74810QDRRRQ1	TPS74533PQWDRVRQ1	UCC27284QDRQ1							
SN21222QDRQ1	TPS78417QDBVRQ1								
TPS1HC100BQPWPRQ1	TPS7B4255QDBVRQ1								

ZVEI ID: SEM-TF-01

In performing change qualifications, Texas Instruments follows integrated circuit industry standards in performing defect mechanism analysis and failure mechanism-based accelerated environmental testing to ensure wafer fab process, assembly process and product quality and

reliability. As encouraged by these standards, TI uses both product-specific and generic (family) data in qualifying its changes. For devices to be categorized as a 'product qualification family' for generic data purposes, they must share similar product, wafer fab process and assembly process elements. The applicability of generic data (also known at TI as Qualification by Similarity (QBS)) is determined by the Reliability Engineering function following these industry standards. Generic data is shown in the qualification report in columns titled "QBS Process" (for wafer fab process), "QBS Package" (for assembly process) and "QBS Product" (for product family).

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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